

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| In re Application of | : | |
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| Phillippe KERTESZ <i>et al.</i> | : | Confirmation No. 8615 |
| | : | |
| U.S. Patent Application No. 10/539,735 | : | Group Art Unit: 2811 |
| | : | |
| Filed: June 20, 2005 | : | Examiner: Hung K. Vu |
| For: | | |
| SURFACE-MOUNTED MICROWAVE PACKAGE AND CORRESPONDING MOUNTING WITH A MULTILAYER CIRCUIT | | |

RESPONSE TO NOTICE OF NON-COMPLIANT
SUPPLEMENTAL PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Notice of Non-Compliant Amendment dated November 28, 2007,
please amend the above-identified application as follows on the accompanying pages.